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July 2014



**FDMA1025P** 

# **Dual P-Channel PowerTrench® MOSFET**

-20V, -3.1A, 155mΩ

#### **Features**

- Max  $r_{DS(on)}$  = 155m $\Omega$  at  $V_{GS}$  = -4.5V,  $I_D$  = -3.1A
- Max  $r_{DS(on)}$  = 220m $\Omega$  at  $V_{GS}$  = -2.5V,  $I_D$  = -2.3A
- Low profile 0.8mm maximum in the new package MicroFET 2X2 mm
- RoHS Compliant
- Free from halogenated compounds and antimony oxides



### **General Description**

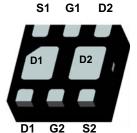
This device is designed specifically as a single package solution for the battery charge switch in cellular handset and other ultraportable applications. It features two independent P-Channel MOSFETs with low on-state resistance for minimum conduction losses. When connected in the typical common source configuration, bi-directional current flow is possible.

The MicroFET 2X2 package offers exceptional thermal performance for its physical size and well suited to linear mode applications.

### Application

■ DC - DC Conversion





PIN 1

S1 1 6 D1
G1 2 5 G2
D2 3 4 S2

MicroFET 2X2

### MOSFET Maximum Ratings T<sub>A</sub> = 25°C unless otherwise noted

Symbol	Parameter		Ratings	Units
V <sub>DS</sub>	Drain to Source Voltage		-20	V
$V_{GS}$	Gate to Source Voltage		±12	V
1	Drain Current -Continuous	(Note 1a)	-3.1	
<sup>I</sup> D	-Pulsed		-6	Α
Б	Power Dissipation for Single Operation	(Note 1a)	1.4	10/
$P_{D}$	Power Dissipation	(Note 1b)	0.7	W
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range		-55 to +150	°C

#### **Thermal Characteristics**

$R_{\theta JA}$	Thermal Resistance Single Operation, Junction to Ambient	(Note 1a)	86	
$R_{\theta JA}$	Thermal Resistance Single Operation, Junction to Ambient	(Note 1b)	173	°C/W
$R_{\theta JA}$	Thermal Resistance Dual Operation, Junction to Ambient	(Note 1c)	69	C/VV
$R_{\theta JA}$	Thermal Resistance Dual Operation, Junction to Ambient	(Note 1d)	151	

#### **Package Marking and Ordering Information**

Device Marking	Device	Package	Package Reel Size Tape Wi		Quantity
025	FDMA1025P	MicroFET 2X2	7"	8mm	3000 units

### **Electrical Characteristics** $T_J = 25^{\circ}C$ unless otherwise noted Parameter

Symbol	Parameter	Test Conditions	s Min	Тур	Max	Units
Off Chara	cteristics					
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	$I_D = -250 \mu A, V_{GS} = 0 V$	-20			V
$\frac{\Delta BV_{DSS}}{\Delta T_{J}}$	Breakdown Voltage Temperature Coefficient	$I_D = -250\mu A$ , referenced to	25°C	14		mV/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS} = -16V,$ $V_{GS} = 0V$ $T_{J} =$	125°C		-1 -100	μА
I <sub>GSS</sub>	Gate to Source Leakage Current	$V_{GS} = \pm 12V, V_{DS} = 0V$			±100	nA

### On Characteristics

V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = -250 \mu A$	-0.4	-0.9	-1.5	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	I <sub>D</sub> = -250μA, referenced to 25°C		-3.8		mV/°C
		$V_{GS} = -4.5V, I_D = -3.1A$		88	155	
r <sub>DS(on)</sub>	Drain to Source On Resistance	$V_{GS} = -2.5V, I_D = -2.3A$		144	220	mΩ
		$V_{GS} = -4.5V$ , $I_D = -3.1A$ , $T_J = 125$ °C		121	220	1
9 <sub>FS</sub>	Forward Transconductance	$V_{DS} = -5V, I_{D} = -3.1A$		6.2		S

### **Dynamic Characteristics**

Ci	ss	Input Capacitance	V = 10V V = 0V	340	450	pF
C	oss	Output Capacitance	V <sub>DS</sub> = -10V, V <sub>GS</sub> = 0V, f = 1MHz	80	105	pF
C,	rss	Reverse Transfer Capacitance	111112	45	70	pF

### **Switching Characteristics**

t <sub>d(on)</sub>	Turn-On Delay Time		5	10	ns
t <sub>r</sub>	Rise Time	$V_{DD} = -10V, I_D = -3.1A$ $V_{GS} = -4.5V, R_{GEN} = 6\Omega$	14	26	ns
t <sub>d(off)</sub>	Turn-Off Delay Time	V <sub>GS</sub> = -4.5V, K <sub>GEN</sub> = 012	13	24	ns
t <sub>f</sub>	Fall Time		8	16	ns
$Q_{g(TOT)}$	Total Gate Charge at 4.5V	$V_{GS} = 0V \text{ to } -4.5V \ V_{DD} = -10V$	3.4	4.8	nC
$Q_{gs}$	Gate to Source Gate Charge	$I_{D} = -3.1A$	0.8		nC
$Q_{gd}$	Gate to Drain "Miller" Charge		1.0		nC

### **Drain-Source Diode Characteristics**

Is	Maximum Continuous Source-Drain Diode Forward			-1.1	Α	
$V_{SD}$	Source to Drain Diode Forward Voltage V <sub>GS</sub> = 0V, I <sub>S</sub> = -1.1A (Note 2)		-0.8	-1.2	V	
t <sub>rr</sub>	Reverse Recovery Time	-I <sub>F</sub> = -3.1A, di/dt = 100A/μs		17	26	ns
Q <sub>rr</sub>	Reverse Recovery Charge			10	15	nC

#### Notes:

- 1.  $R_{\theta JA}$  is determined with the device mounted on a 1 in<sup>2</sup> oz. copper pad on a 1.5 x 1.5 in. board of FR-4 material.  $R_{\theta JC}$  is guaranteed by design while  $R_{\theta JA}$  is determined by the user's board design.

  (a)  $R_{\theta JA} = 86$  °C/W when mounted on a 1 in<sup>2</sup> pad of 2 oz copper, 1.5 " x 1.5 " x 0.062 " thick PCB. For single operation.

  - (b) R<sub>0JA</sub> = 173 °C/W when mounted on a minimum pad of 2 oz copper. For single operation.
  - (c)  $R_{\theta JA}$  = 69 °C/W when mounted on a 1 in<sup>2</sup> pad of 2 oz copper, 1.5 " x 1.5 " x 0.062 " thick PCB. For dual operation.
  - (d)  $R_{\theta JA}$  = 151  $^{o}$ C/W when mounted on a minimum pad of 2 oz copper. For dual operation.



a)86 °C/W when mounted on a 1 in<sup>2</sup> pad of 2 oz copper.

b)173 °C/W when mounted on a minimum pad of 2 oz copper.



c)69 °C/W when mounted on a 1 in<sup>2</sup> pad of 2 oz copper.



d)151 °C/W when mounted on a minimum pad of 2 oz copper.

2. Pulse Test : Pulse Width < 300 us, Duty Cycle < 2.0

### Typical Characteristics T<sub>J</sub> = 25°C unless otherwise noted

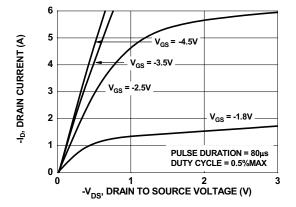


Figure 1. On Region Characteristics

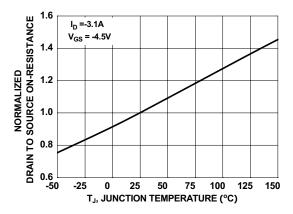


Figure 3. Normalized On Resistance vs Junction Temperature

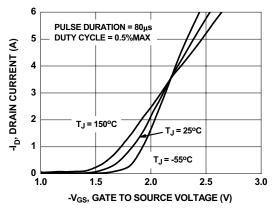


Figure 5. Transfer Characteristics

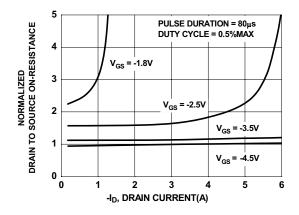


Figure 2. Normalized On-Resistance vs Drain Current and Gate Voltage

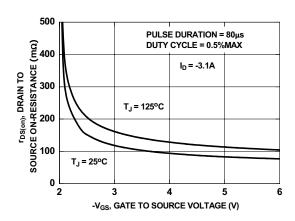


Figure 4. On-Resistance vs Gate to Source Voltage

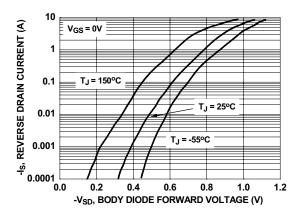


Figure 6. Source to Drain Diode Forward Voltage vs Source Current

### Typical Characteristics T<sub>J</sub> = 25°C unless otherwise noted

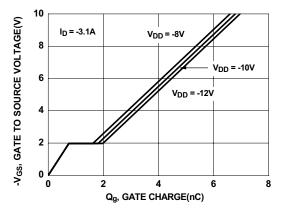
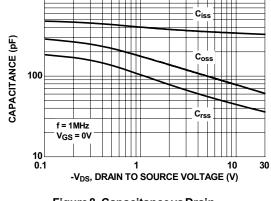


Figure 7. Gate Charge Characteristics



1000

Figure 8. Capacitance vs Drain to Source Voltage

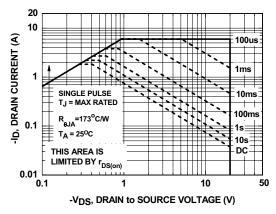


Figure 9. Forward Bias Safe Operating Area

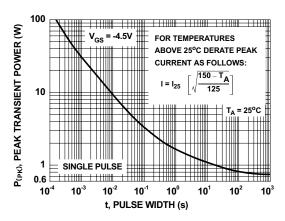


Figure 10. Single Pulse Maximum Power Dissipation

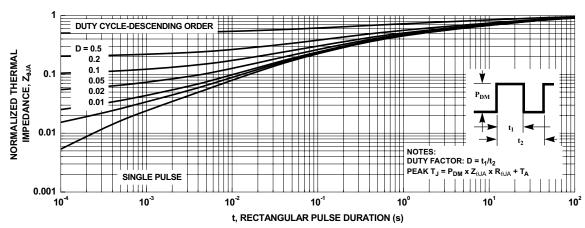
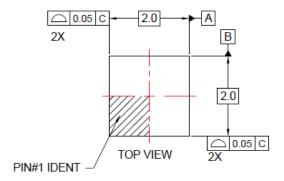
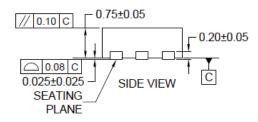
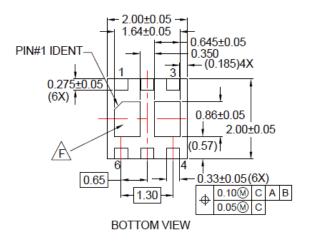


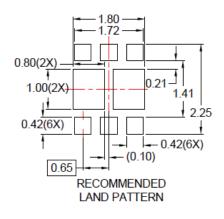
Figure 11. Transient Thermal Response Curve

### **Dimensional Outline and Pad Layout**









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